

#### **Features**

- Very Low FOM R<sub>DS(on)</sub>×Q<sub>g</sub>
- · Epoxy Meets UL 94 V-0 Flammability Rating
- · Moisture Sensitivity Level 1
- · Halogen Free Available Upon Request By Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# **Maximum Ratings**

Operating Junction Temperature Range : -55°C to +150°C

• Storage Temperature Range: -55°C to +150°C

• Thermal Resistance: 62°C/W Junction to Ambient

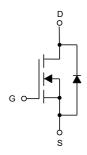
· Thermal Resistance: 2°C/W Junction to Case

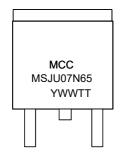
Parameter	Symbol	Rating	Unit		
Drain-Source Voltage	V <sub>DS</sub>	650	V		
Gate-Source Volltage	V <sub>GS</sub>	±30	V		
Continuous Drain Current	T <sub>C</sub> =25°C		7	А	
	T <sub>C</sub> =100°C	- I <sub>D</sub>	4.2		
Pulsed Drain Current (Note 1	I <sub>DM</sub>	21	А		
Single Pulse Avalanche Er	E <sub>AS</sub>	E <sub>AS</sub> 142			
Avalanche Current	I <sub>AR</sub>	1.3	Α		
Repetitive Avalanche Energy		E <sub>AR</sub>	0.21	mJ	
Total Power Dissipation	T <sub>C</sub> =25°C	P <sub>D</sub>	63	W	

### Note:

- 1. Repetitive Rating; Pulse Width Limited by Maximum Junction Temperature.
- 2.  $I_{AS}$ =2.4A,  $V_{DD}$ =50V,  $R_{G}$ =25 $\Omega$ , Starting  $T_{J}$ =25 $^{\circ}$ C.

# **Internal Structure and Marking Code**

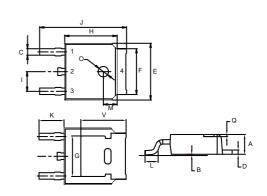




YWWTT: 5 codes in total Y is the year WW is the cycle TT is the line type

# N-CHANNEL Super-Junction Power MOSFET

# **DPAK(TO-252)**



- 1. Gate
- 2,4. Drain
  - 3. Source

DIMENSIONS					
DIM INCHES		MM		NOTE	
DIIVI	MIN	MAX	MIN	MAX	NOTE
Α	0.087	0.094	2.20	2.40	
В	0.000	0.005	0.00	0.13	
С	0.026	0.034	0.66	0.86	
D	0.018	0.023	0.46	0.58	
Е	0.256	0.264	6.50	6.70	
F	0.201	0.215	5.10	5.46	
G	0.190		4.83		TYP.
Н	0.236	0.244	6.00	6.20	
I	0.086	0.094	2.18	2.39	
J	0.386	0.409	9.80	10.40	
K	0.1	14	2.9	90	TYP.
L	0.055	0.067	1.40	1.70	
М	0.063		1.60		TYP.
0	0.043	0.051	1.10	1.30	
Q	0.000	0.012	0.00	0.30	
V	0.211		5.35		TYP.

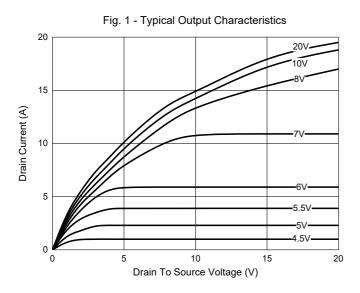


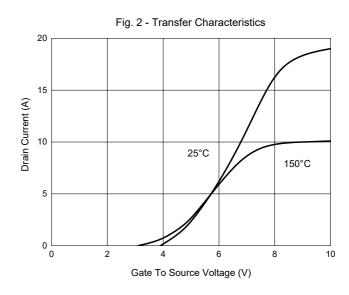
# Electrical Characteristics @ 25°C (Unless Otherwise Specified)

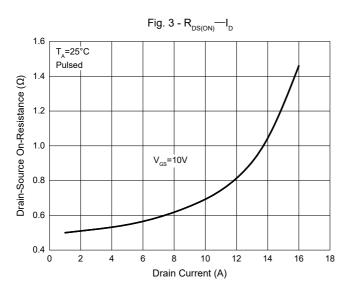
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static Characteristics			'	•		
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	650			V
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±30V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V			1	μA
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.5		4	V
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A		0.53	0.6	Ω
Gate Resistance	R <sub>G</sub>	f = 1.0MHz Open Drain		19		Ω
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =3.5A		0.9	1.2	V
Continuous Body Diode Current	Is				7	Α
Dynamic Characteristics			'	•		
Input Capacitance	C <sub>iss</sub>			509		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V,f=1MHz		23		
Reverse Transfer Capacitance	C <sub>rss</sub>			1.5		
Total Gate Charge	$Q_g$			13		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DD</sub> =520V,V <sub>GS</sub> =10V,I <sub>D</sub> =7A		2.8		nC
Gate-Drain Charge	$Q_{gd}$			5.6		
Turn-On Delay Time	t <sub>d(on)</sub>			55		
Turn-On Rise Time	t <sub>r</sub>	V <sub>DD</sub> =400V, I <sub>D</sub> =7A,		61		ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_G=25\Omega$		117		
Turn-Off Fall Time	t <sub>f</sub>			42		
Reverse Recovery Time	t <sub>rr</sub>			321		ns
Reverse Recovery Charge	Q <sub>rr</sub>	$V_R$ =400V, $I_F$ =7A, $di_F/dt = 100A/\mu s$		3.4		μC
Peak Reverse Recovery Current	I <sub>rrm</sub>	1		21.2		Α

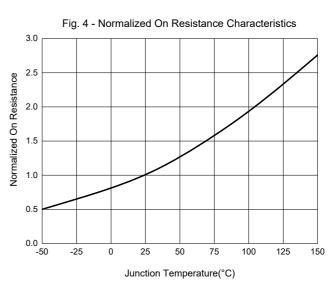


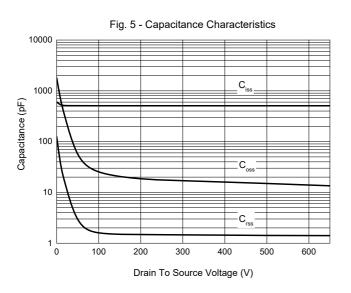
## **Curve Characteristics**

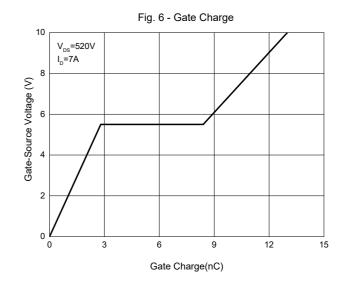














# **Ordering Information**

Device	Packing
Part Number-TP	Tape&Reel: 2.5Kpcs/Reel

Note: Adding "-HF" Suffix for Halogen Free, eg. Part Number-TP-HF

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